

TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT process) (Bias Resistor built-in Transistor)

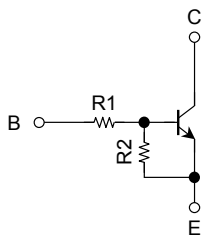
RN1107FT, RN1108FT, RN1109FT

Switching, Inverter Circuit, Interface Circuit and Driver Circuit Applications

Unit: mm

- High-density mount is possible because of devices housed in very thin TESH packages.
- Incorporating a bias resistor into a transistor reduces parts count. Reducing the parts count enable the manufacture of ever more compact equipment and save assembly cost.
- Wide range of resistor values are available to use in various circuit designs.
- Complementary to RN2107FT~RN2109FT

Equivalent Circuit and Bias Resistor Values



Type No.	R1 (kΩ)	R2 (kΩ)
RN1107FT	10	47
RN1108FT	22	47
RN1109FT	47	22

1. BASE	
2. EMITTER	
3. COLLECTOR	
TESM	
JEDEC	—
JEITA	—
TOSHIBA	2-1B1A

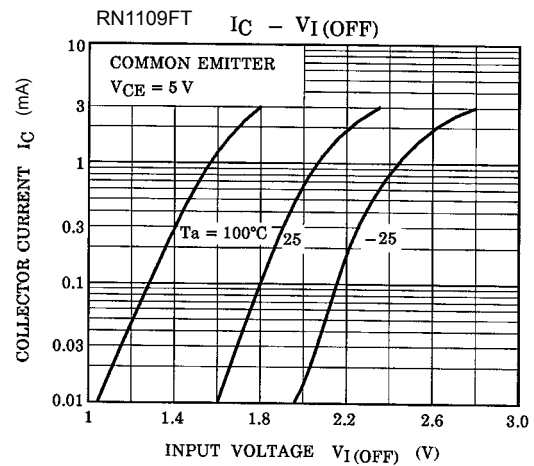
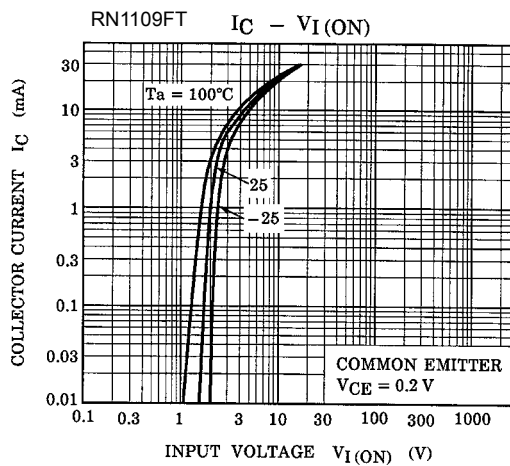
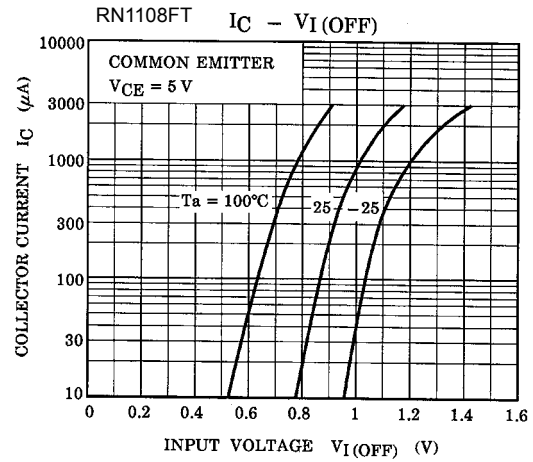
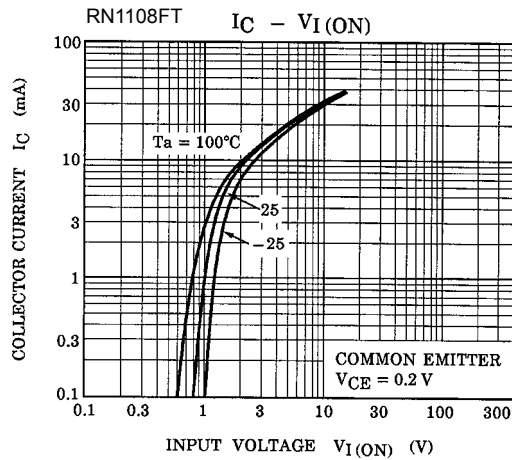
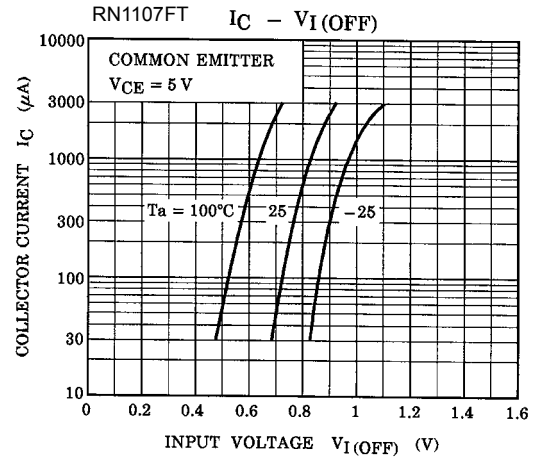
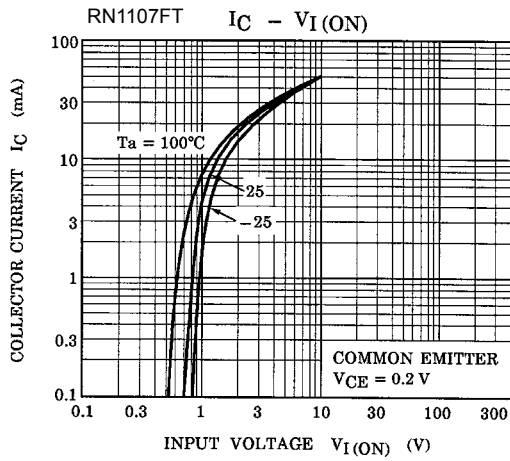
Weight:0.0022g (typ.)

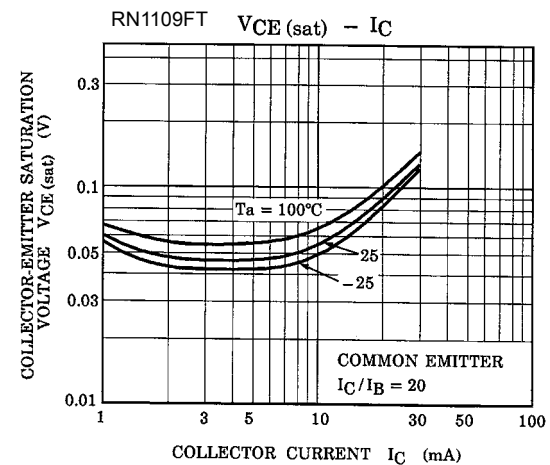
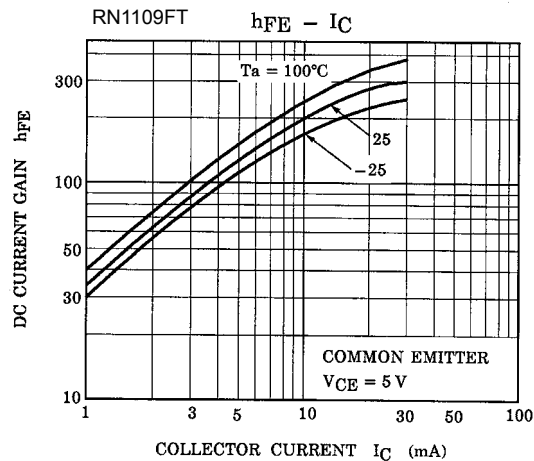
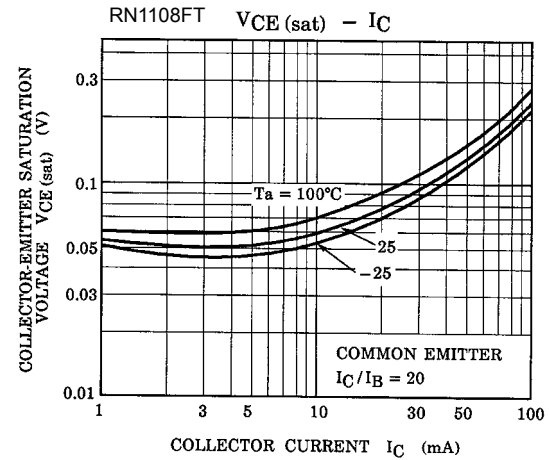
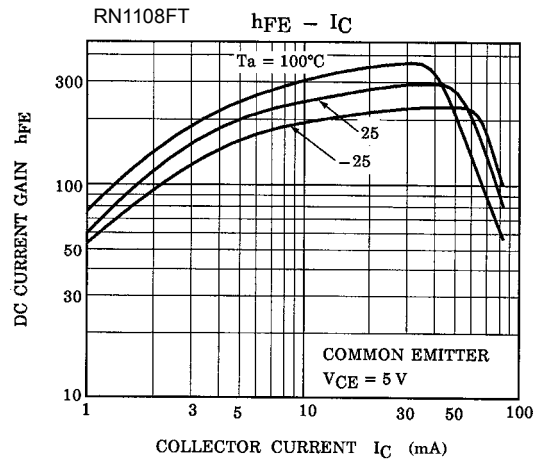
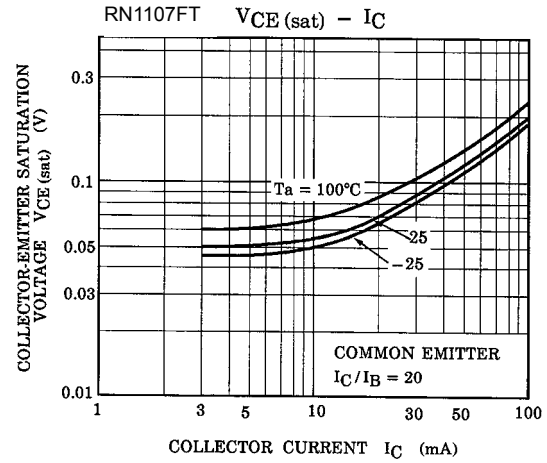
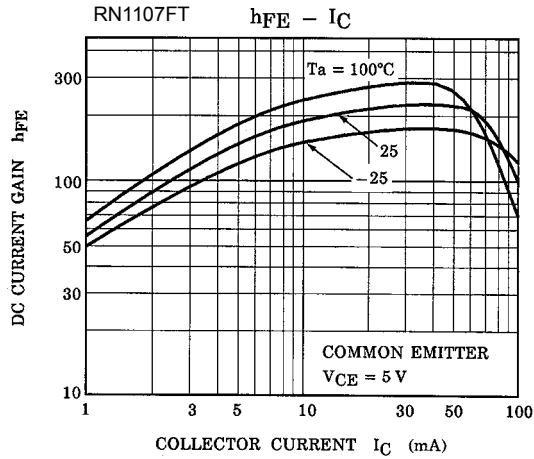
Maximum Ratings (Ta = 25°C)

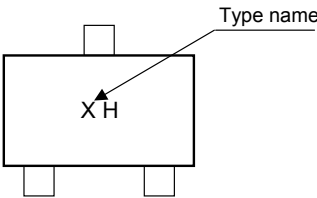
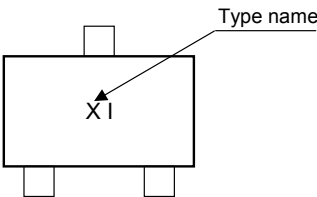
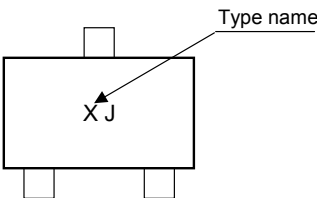
Characteristics		Symbol	Rating	Unit
Collector-base voltage	RN1107FT~1109FT	V _{CBO}	50	V
Collector-emitter voltage		V _{CEO}	50	V
Emitter-base voltage	RN1107FT	V _{EBO}	6	V
	RN1108FT		7	
	RN1109FT		15	
Collector current	RN1107FT~1109FT	I _C	100	mA
Collector power dissipation		P _C	100	mW
Junction temperature		T _J	150	°C
Storage temperature range		T _{stg}	−55~150	°C

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	RN1107FT~1109FT	I_{CBO}	$V_{CB} = 50\text{ V}, I_E = 0$	—	—	100	nA
		I_{CEO}	$V_{CE} = 50\text{ V}, I_B = 0$	—	—	500	
Emitter cut-off current	RN1107FT	I_{EBO}	$V_{EB} = 6\text{ V}, I_C = 0$	0.081	—	0.15	mA
	RN1108FT		$V_{EB} = 7\text{ V}, I_C = 0$	0.078	—	0.145	
	RN1109FT		$V_{EB} = 15\text{ V}, I_C = 0$	0.167	—	0.311	
DC current gain	RN1107FT	h_{FE}	$V_{CE} = 5\text{ V}, I_C = 10\text{ mA}$	80	—	—	
	RN1108FT			80	—	—	
	RN1109FT			70	—	—	
Collector-emitter saturation voltage	RN1107FT~1109FT	$V_{CE(sat)}$	$I_C = 5\text{ mA}, I_B = 0.25\text{ mA}$	—	0.1	0.3	V
Input voltage (ON)	RN1107FT	$V_{I(ON)}$	$V_{CE} = 0.2\text{ V}, I_C = 5\text{ mA}$	0.7	—	1.8	V
	RN1108FT			1.0	—	2.6	
	RN1109FT			2.2	—	5.8	
Input voltage (OFF)	RN1107FT	$V_{I(OFF)}$	$V_{CE} = 5\text{ V}, I_C = 0.1\text{ mA}$	0.5	—	1.0	V
	RN1108FT			0.6	—	1.16	
	RN1109FT			1.5	—	2.6	
Transition frequency	RN1107FT~1109FT	f_T	$V_{CE} = 10\text{ V}, I_C = 5\text{ mA}$	—	250	—	MHz
Collector output capacitance	RN1107FT~1109FT	C_{ob}	$V_{CB} = 10\text{ V}, I_E = 0, f = 1\text{ MHz}$	—	3	6	pF
Input resistor	RN1107FT	R1	—	7	10	13	kΩ
	RN1108FT			15.4	22	28.6	
	RN1109FT			32.9	47	61.1	
Resistor ratio	RN1107FT	R1/R2	—	0.191	0.213	0.232	
	RN1108FT			0.421	0.468	0.515	
	RN1109FT			1.92	2.14	2.35	





Type Name	Marking
RN1107FT	 <p>The diagram shows a rectangular component with a top pin and two bottom pins. An arrow points from the text 'Type name' to the marking 'XH' on the component.</p>
RN1108FT	 <p>The diagram shows a rectangular component with a top pin and two bottom pins. An arrow points from the text 'Type name' to the marking 'XI' on the component.</p>
RN1109FT	 <p>The diagram shows a rectangular component with a top pin and two bottom pins. An arrow points from the text 'Type name' to the marking 'XJ' on the component.</p>

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